













- ► LED Array + MCPCB
- ► 50x50x2.7mm
- ► Warm White 3000K

N0W63M02





# 5A5A LED Module Compliant





#### **FEATURES:**

Package: Top View EMC White LED Array on MCPCB

Forward Current: 4000mA Forward Voltage (typ.): 26.4V

Luminous Flux (typ.): 11875lm@4000mA

Colour: Warm White

Colour Temperature (CCT): 3000K

Viewing angle: 120°

**Materials:** 

Die: InGaN

Resin: Silicon (Yellow Diffused)

Package: EMC

Operating Temperature: -40~+105°C Storage Temperature: -40~+105°C

**Grouping parameters:** 

Forward Voltage

Luminous Flux

**CIE Chromaticity** 

Soldering methods: Reflow Soldering MSL Level: 2 according to J-STD020

Packing: 6pcs/tray; in carton

#### **APPLICATIONS:**

- High Bay Light
- Street Lighting
- **Commercial Lighting**
- **Tunnel Light**
- Spotlight



#### **CHARACTERISTICS:**

# Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	IF	4000	mA
Pulse Forward Current (Duty 1/10, width≤100μS)	IPF	4800	mA
Power Dissipation	P <sub>D</sub>	102,400	mW
Junction Temperature	Tj	120	°C
Operating Temperature	T <sub>OPR</sub>	-40~+105	°C
Storage Temperature	T <sub>STG</sub>	-40~+105	°C

# Electrical & Optical Characteristics (Ta=25°C, RH=60%)

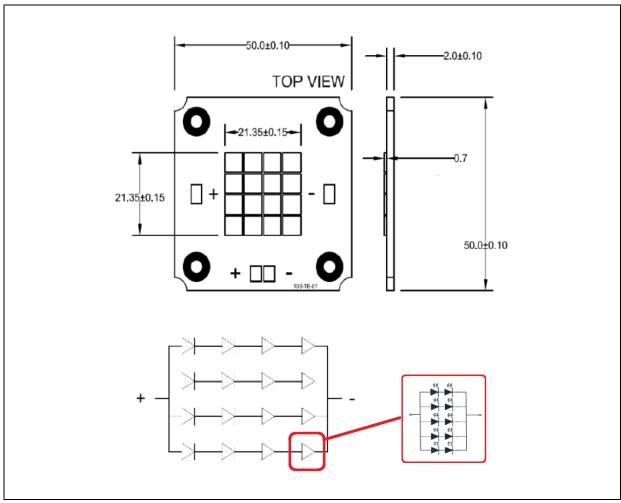
Parameter	Symbol	Values			Unit	Test
Parameter	Зуппоп	Min.	Тур.	Max.	Offic	Condition
Forward Voltage	VF	23.0	26.4	29.6	V	I <sub>F</sub> =4000mA
Luminous Flux	Ф۷	11200	11875		lm	I <sub>F</sub> =4000mA
Chromaticity Coordinates	Х		0.4342			I <sub>F</sub> =4000mA
	Υ		0.4028			
Colour Temperature	ССТ	2870	3045	3220	К	I <sub>F</sub> =4000mA
Viewing Angle	2θ <sub>1/2</sub>		120		deg	I <sub>F</sub> =4000mA

<sup>1.</sup> Luminous flux ( $\Phi_V$ ) ±10%, Forward Voltage ( $V_F$ ) ±0.1V, CRI ±2



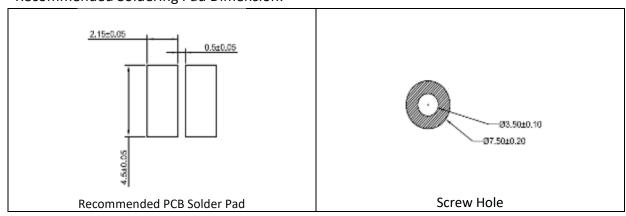
#### **OUTLINE DIMENSION:**

#### Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

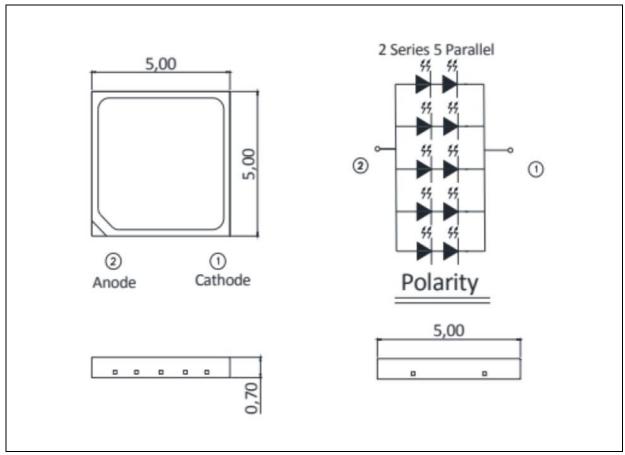
#### **Recommended Soldering Pad Dimension:**



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.

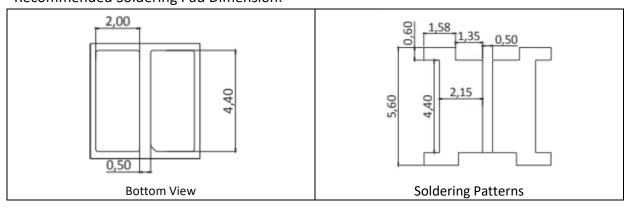


## Single LED Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

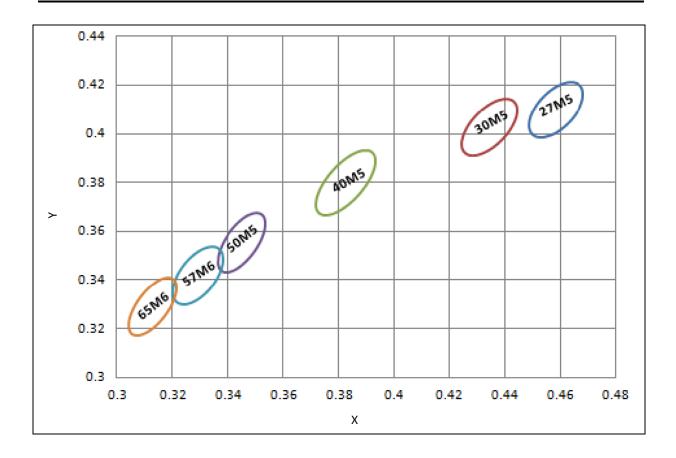
## **Recommended Soldering Pad Dimension:**



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



## **CIE CHROMATICITY DIAGRAM:**



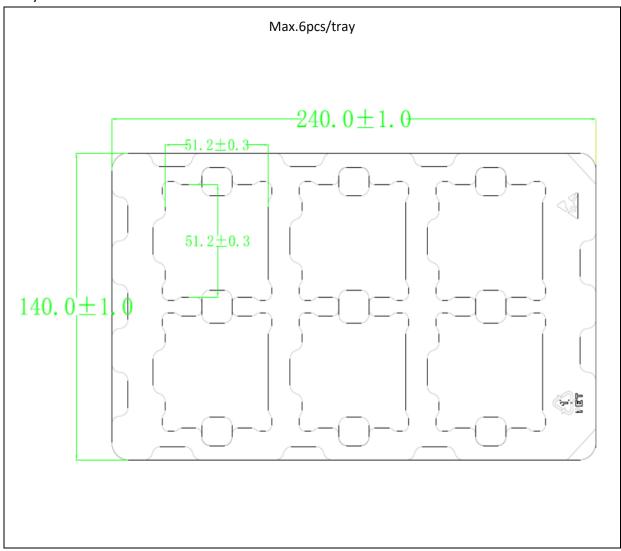
#### Chromaticity Coordinates Classifications (IF = 4000mA):

	Cada	Centre		Radius		Angle
a D D D	Code	Х	Υ	а	b	Φ
	30M3	0.4342	0.4028	0.00834	0.00408	53.13
	30M5	0.4342	0.4028	0.01390	0.00680	53.13



## **PACKING SPECIFICATION:**

# Tray Dimension:





#### **PRECAUTIONS OF USE:**

#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

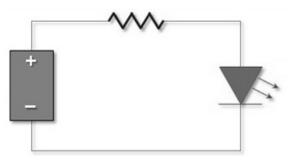
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



# **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	25/11/2022	Datasheet set-up.